onsemi

<u>Silicon Carbide (SiC) Diode</u> – EliteSiC, TO247-3, 60 A, 650 V SiC Merged PiN-Schottky (MPS) Diode

UJ3D06560KSD

Description

onsemi offers the 3rd generation of high performance SiC Merged-PiN-Schottky (MPS) diodes. With zero reverse recovery charge and 175 °C maximum junction temperature, these diodes are ideally suited for high frequency and high efficiency power systems with minimum cooling requirements.

Features

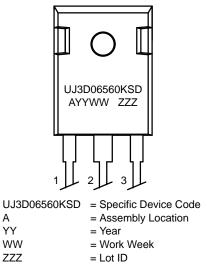
- 175 °C Maximum Operating Junction Temperature
- Easy Paralleling
- Extremely Fast Switching not Dependent on Temperature
- No Reverse or Forward Recovery
- Enhanced Surge Current Capability, MPS Structure
- Excellent Thermal Performance, Ag Sintered
- 100% UIS Tested
- This Device is Pb-Free, Halogen Free and is ROHS Compliant

Typical Applications

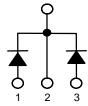
- Power Converters
- Industrial Motor Drives
- Switching-mode Power Supplies
- Power Factor Correction Modules



MARKING DIAGRAM







ORDERING INFORMATION

See detailed ordering and shipping information on page 4 of this data sheet.

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MAXIMUM RATINGS

Parameter	Symbol	Test Conditions	Value (Leg/Device)	Unit	
DC Blocking Voltage	V _R		650	V	
Repetitive Peak Reverse Voltage, $T_J = 25 \ ^{\circ}C$	V _{RRM}		650	V	
Surge Peak Reverse Voltage	V _{RSM}		650	V	
Maximum DC Forward Current	١ _F	T _C = 140 °C	30/60	А	
Non-repetitive Forward Surge Current Sine	I _{FSM}	$T_C = 25 \ ^\circ C$, $t_p = 10 \ ms$	165/330	А	
Halfwave		T _C = 110 °C, t _p = 10 ms	150/300		
Repetitive Forward Surge Current Sine	I _{FRM}	$T_C = 25 \ ^\circ C$, $t_p = 10 \ ms$	107.2/214.4	А	
Halfwave, $D = 0.1$		T_{C} = 110 °C, t_{p} = 10 ms	66.1/132.2	1	
Non-repetitive Peak Forward Current	I _{F, max}	T _C = 25 °C, t _p = 10 μs	1250/2500	А	
		T _C = 110 °C, t _p = 10 μs	1250/2500		
i ² t Value	∫i ² dt	$T_C = 25 \ ^\circ C$, $t_p = 10 \ ms$	136/544	A ² s	
		T_{C} = 110 °C, t_{p} = 10 ms	112/448		
Diode dV/dt Ruggedness	dV/dt	V _R = 0–650 V	200	V/ns	
Power Dissipation	P _{tot}	T _C = 25 °C	288.5/577	W	
		T _C = 140 °C	67.3/134.6		
Maximum Junction Temperature	T _{J, max}		175	°C	
Operating and Storage Temperature	T _J , T _{STG}		-55 to 175	°C	
Soldering Temperatures, Wavesoldering only Allowed at Leads	T _{sold}	1.6 mm from case for 10 s	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ELECTRICAL CHARACTERISTICS

			Value (Leg/Device)			
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Forward Voltage	V _F	I_F = 30 A/60 A, T_J = 25 °C	-	1.5	1.7	V
		I_F = 30 A/60 A, T_J = 150 $^\circ C$	-	1.77	2.10	
		I_F = 30 A/60 A, T_J = 175 °C	-	1.85	2.25	
Reverse Current	I _R	V_R = 650 V, T_J = 25 °C	-	30/60	370/740	μΑ
		V_R = 650 V, T_J = 175 °C	-	390/780	-	
Total Capacitive Charge (Note 1)	Q _C	V _R = 400 V	-	72/144	-	nC
Total Capacitance	С	V _R = 1 V, f = 1 MHz	-	990/1980	-	pF
		V _R = 300 V, f = 1 MHz	-	117/234	-	
		V _R = 600 V, f = 1 MHz	-	101/202	-	
Capacitance Stored Energy	E _C	V _R = 400 V	-	10.5/21	-	μJ

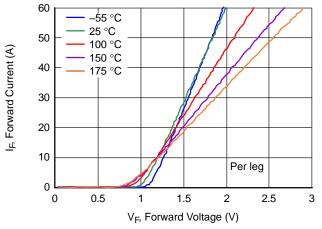
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

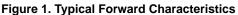
1. Q_C is independent on T_J , di_F/dt, and I_F as shown in the application note AND90316/D

THERMAL CHARACTERISTICS

			Value (Leg/Device)		/ice)	
Parameter	Symbol	Test Conditions	Min	Тур	Мах	Unit
Thermal Resistance, Junction-to-Case	R_{\thetaJC}		-	0.4/0.2	0.52/026	°C/W

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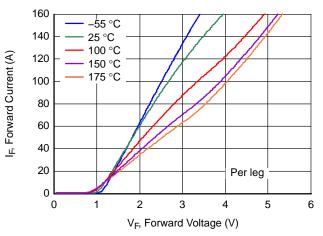
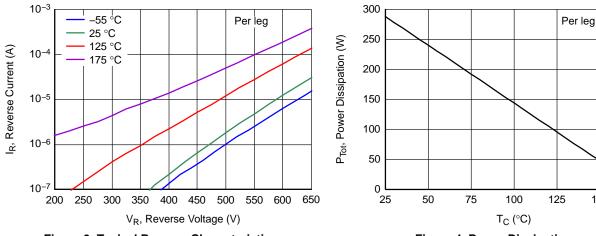


Figure 2. Typical Forward Characteristics in Surge Current



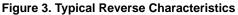


Figure 4. Power Dissipation

Ш

150

D = 0.5 D = 0.3

D = 0.1 D = 0.05

D = 0.02D = Single Pulse

1.E-02

1.E–01

175

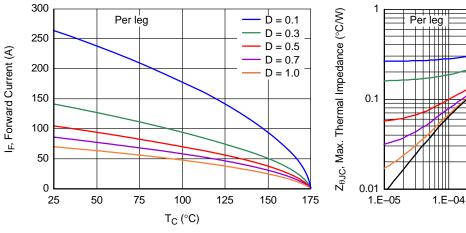


Figure 5. Diode Forward Current



1.E-03

t, Time (s)

UJ3D06560KSD

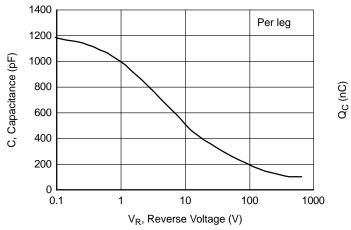


Figure 7. Capacitance vs. Reverse Voltage at 1 MHz

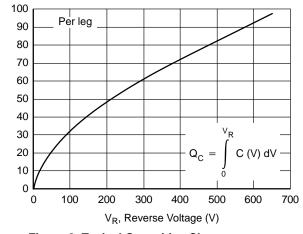
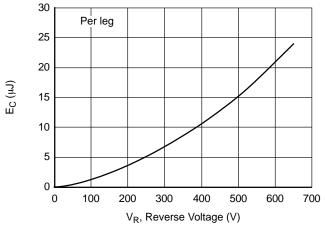
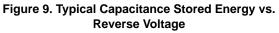


Figure 8. Typical Capacitive Charge vs. Reverse Voltage

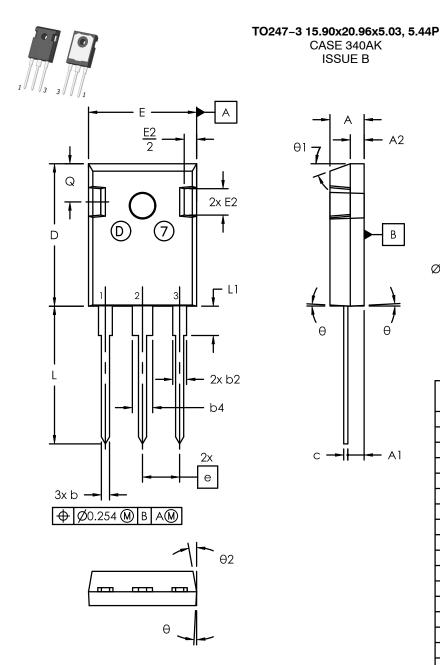




ORDERING INFORMATION

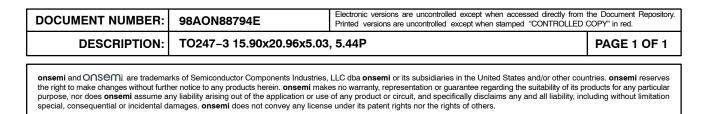
Part Number	Marking	Package	Shipping
UJ3D06560KSD	UJ3D06560KSD	TO247-3 (Pb-Free, Halogen Free)	600 / Tube

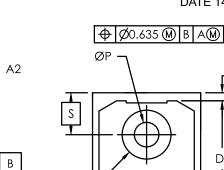
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NOTE:

- 1. Dimensioning and tolerancing as per ASME Y14.5 2018
- 2. Controlling dimension : millimeters
- 3. Package Outline in compliance with JEDEC standard var. AD.
- 4. Dimensions D & E does not include mold flash.
- ØP to have max draft angle of 1.7° to the top with max. hole 5. diameter of 3.91mm.





3

2

1

ØP1

θ

- A1

DATE 14 APR 2025

D2

Dl

 ◄-	—— E1 —					
SYM	millimeters					
31/01	MIN	NOM	MAX			
A	4.70	5.03	5.31			
A1	2.21	2.40	2.59			
A2	1.50	2.03	2.49			
b	0.99	1.20	1.40			
b2	1.65	2.03	2.39			
b4	2.59	3.00	3.43			
С	0.38	0.60	0.89			
C D	20.70	20.96	21.46			
D1	13.08	_	-			
D2	0.51	1.19	1.35			
E	15.49	15.90	16.26			
е	5.44 BSC					
E1	13.00	13.30	13.60			
E2	3.43	3.89	5.20			
L	19.62	20.27	20.32			
L1	-	-	4.50			
ØP	3.40	3.60	3.80			
ØP1	7.06	7.19	7.39			
Q S	5.38	5.62	6.20			
S	6.15 BSC					
θ	3°					
θ1	20°					
θ2	10°					

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